



### Features

- QSFP-DD MSA compliant
- 4 CWDM lanes MUX/DEMUX design
- 100G Lambda MSA 400G-FR4 Specification compliant
- Up to 2km transmission on single mode fiber (SMF) with FEC
- Operating case temperature: 0 to 70°C
- 8x53.125Gb/s electrical interface (400GAUI-8)
- Data Rate 106.25Gbps (PAM4) per channel.
- Maximum power consumption 12W
- Duplex LC connector
- RoHS compliant

### Applications

- Data Center Interconnect
- 400G Ethernet
- Infiniband interconnects
- Enterprise networking

### Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Units
Storage Temperature	$T_s$	-40	85	°C
Operating Case Temperature	$T_{op}$	0	70	°C
Power Supply Voltage	$V_{cc}$	-0.5	3.6	V
Relative Humidity (non-condensation)	$RH$	0	85	%
Damage Threshold, each Lane	$THd$	4.5		dBm

### Recommended Operating Conditions

Parameter	Symbol	Min.	Typ.	Max.	Units	Note
Operating Temperature	$T_{op}$	0		70	°C	
Power Supply Voltage	$V_{cc}$	3.135	3.3	3.465	V	
Data Rate, each Lane			26.5625		GBd	PAM4
Data Rate Accuracy		-100		100	ppm	
Pre-FEC Bit Error Ratio				$2.4 \times 10^{-4}$		
Post-FEC Bit Error Ratio				$1 \times 10^{-12}$		1
Link Distance	$D$	0.002		2	Km	2

Notes:

1. FEC provided by host system.
2. FEC required on host system to support maximum distance.

### Diagnostics Monitoring

Parameter	Symbol	Accuracy	Unit	Notes
Temperature monitor absolute error	DMI_Temp	$\pm 3$	°C	Over operating temperature range
Supply voltage monitor absolute error	DMI_VCC	$\pm 0.1$	V	Over full operating range
Channel RX power monitor absolute error	DMI_RX_Ch	$\pm 2$	dB	1
Channel Bias current monitor	DMI_Ibias_Ch	$\pm 10\%$	mA	
Channel TX power monitor absolute error	DMI_TX_Ch	$\pm 2$	dB	1

Notes:

1. Due to measurement accuracy of different single mode fibers, there could be an additional +/-1 dB fluctuation, or a +/- 3 dB total accuracy.

### Transmitter Electro-Optical Characteristics (each Lane)

Parameter	Test Point	Min	Typ.	Max	Units	Notes
Power Consumption				12	W	
Supply Current	<i>I<sub>cc</sub></i>			3.64	A	
Signaling Rate, each Lane	<i>TP1</i>	26.5625 ± 100 ppm			GBd	
Differential pk-pk Input Voltage Tolerance	<i>TP1a</i>	900			mVpp	1
Differential Termination Mismatch	<i>TP1</i>			10	%	
Differential Input Return Loss	<i>TP1</i>	IEEE 802.3-2015 Equation (83E-5)			dB	
Differential to Common Mode Input Return Loss	<i>TP1</i>	IEEE 802.3-2015 Equation (83E-6)			dB	
Module Stressed Input Test	<i>TP1a</i>	See IEEE 802.3bs 120E.3.4.1				2
Single-ended Voltage Tolerance Range (Min)	<i>TP1a</i>	-0.4 to 3.3			V	
DC Common Mode Input Voltage	<i>TP1</i>	-350		2850	mV	3
Wavelength Assignment	<i>L0</i>	1264.5	1271	1277.5	nm	
	<i>L1</i>	1284.5	1291	1297.5	nm	
	<i>L2</i>	1304.5	1311	1317.5	nm	
	<i>L3</i>	1324.5	1331	1337.5	nm	
Data Rate, each Lane		53.125 ± 100 ppm			GBd	
Modulation Format		PAM4				
Side-mode Suppression Ratio	<i>SMSR</i>	30			dB	
Total Average Launch Power	<i>P<sub>r</sub></i>			9.3	dBm	
Average Launch Power, each Lane	<i>P<sub>AVG</sub></i>	-3.3		3.5	dBm	4
Outer Optical Modulation Amplitude (OMA <sub>outer</sub> ), each Lane	<i>P<sub>OMA</sub></i>	-0.3		3.7	dBm	5
Launch Power in OMA <sub>outer</sub> minus TDECQ, each Lane					dB	
	for ER ≥ 4.5dB	-1.7				
	for ER < 4.5dB	-1.6				

Parameter	Test Point	Min	Typ.	Max	Units	Notes
Transmitter and Dispersion Eye Clouser for PAM4, each Lane	<i>TDECQ</i>			3.4	dB	
$TDECQ - 10 \cdot \log_{10}(C_{eq})$ , each Lane				3.4	dB	6
Extinction Ratio	<i>ER</i>	3.5			dB	
Difference in Launch Power between any Two Lanes (OMA <sub>outer</sub> )				4	dB	
RIN <sub>17.1OMA</sub>	<i>RIN</i>			-136	dB/Hz	
Optical Return Loss Tolerance	TOL			17.1	dB	
Transmitter Reflectance	R <sub>T</sub>			-26	dB	
Transmitter Transition Time				17	ps	
Average Launch Power of OFF Transmitter, each Lane	P <sub>off</sub>			-20	dBm	

Notes:

1. With the exception to IEEE 802.3bs 120E.3.1.2 that the pattern is PRBS31Q or scrambled idle.
2. Meets BER specified in IEEE 802.3bs 120E.1.1.
3. DC common mode voltage generated by the host. Specification includes effects of ground offset voltage. Average launch power, each lane (min) is informative and not the principal indicator of signal strength. A transmitter with launch power below this value cannot be compliant; however, a value above this does not ensure compliance.
4. Average launch power, each lane (min) is informative and not the principal indicator of signal strength. A transmitter with launch power below this value cannot be compliant; however, a value above this does not ensure compliance.
5. Even if the TDECQ < 1.4 dB for an extinction ratio of ≥ 4.5 dB or TDECQ < 1.3 dB for an extinction ratio of < 4.5 dB, the OMA<sub>outer</sub> (min) must exceed the minimum value specified here.
6. C<sub>eq</sub> is a coefficient defined in IEEE Std 802.3-2018 clause 121.8.5.3 which accounts for reference equalizer noise enhancement.

### Receiver Electro-Optical Characteristics (each Lane)

Parameter	Test Point	Min	Typ.	Max	Units	Notes	
Signaling Rate, each lane	TP4	26.5625 ± 100 ppm			GBd		
Differential Peak-to-Peak Output Voltage	TP4			900	mVpp		
AC Common Mode Output Voltage, RMS	TP4			17.5	mV		
Differential Termination Mismatch	TP4			10	%		
Differential Output Return Loss	TP4			IEEE 802.3-2015 Equation (83E-2)			
Common to Differential Mode Conversion Return Loss	TP4			IEEE 802.3-2015 Equation (83E-3)			
Transition Time, 20% to 80%	TP4	9.5			ps		
Near-end Eye Symmetry Mask Width (ESMW)	TP4		0.265		UI		
Near-end Eye Height, Differential	TP4	70			mV		
Far-end Eye Symmetry Mask Width (ESMW)	TP4		0.2		UI		
Far-end Eye Height, Differential	TP4	30			mV		
Far-end Pre-cursor ISI Ratio	TP4	-4.5		2.5	%		
Common Mode Output Voltage (Vcm)	TP4	-350		2850	mV	1	
Data Rate, each Lane		53.125 ± 100 ppm			GBd		
Modulation Format		PAM4					
Damage Threshold, each Lane	THd	4.5			dBm	2	
Average Receive Power, each Lane		-7.3		3.5	dBm	3	
Receive Power (OMAouter), each Lane				3.7	dBm		
Difference in Receiver Power between any Two Lanes (OMAouter)				4.1	dB		
Receiver Sensitivity (OMAouter), each Lane	SEN			Equation (1)		dBm	4
Stressed Receiver Sensitivity (OMAouter), each Lane	SRS			-2.6	dBm	5	

Parameter	Test Point	Min	Typ.	Max	Units	Notes
Receiver Reflectance	$R_R$			-26	dB	
LOS Assert	LOSA	-20			dBm	
LOS De-assert	LOSD			-10.3	dBm	
LOS Hysteresis	LOSH	0.5			dB	

**Stressed Conditions for Stress Receiver Sensitivity (Note 6)**

Stressed Eye Closure for PAM4 (SECQ), Lane under Test			3.4		dB	
SECQ – $10 \cdot \log_{10}(C_{eq})$ , Lane under Test				3.4	dB	
OMAouter of each Aggressor Lane			1.5		dBm	

Notes:

- DC common mode voltage generated by the host. Specification includes effects of ground offset voltage.
- Average receive power, each lane (min) is informative and not the principal indicator of signal strength. A received power below this value cannot be compliant; however, a value above this does not ensure compliance.
- The receiver shall be able to tolerate, without damage, continuous exposure to a modulated optical input signal having this power level on one lane. The receiver does not have to operate correctly at this input power.
- Average receive power, each lane (min) is informative and not the principal indicator of signal strength. A received power below this value cannot be compliant; however, a value above this does not ensure compliance.
- The receiver shall be able to tolerate, without damage, continuous exposure to an optical input signal having this average power level.
- Receiver sensitivity (OMAouter) is informative and is defined for a transmitter with a value of SECQ up to 3.4 dB. Receiver sensitivity should meet Equation (1), which is illustrated in figure below.

$$= \max(-4.6, -6.0) \quad (1)$$

Where:

RS is the receiver sensitivity, and

SECQ is the SECQ of the transmitter used to measure the receiver sensitivity.

- Measured with conformance test signal at TP3 for the BER equal to  $2.4 \times 10^{-4}$ .
- These test conditions are for measuring stressed receiver sensitivity. They are not characteristics of the receiver.

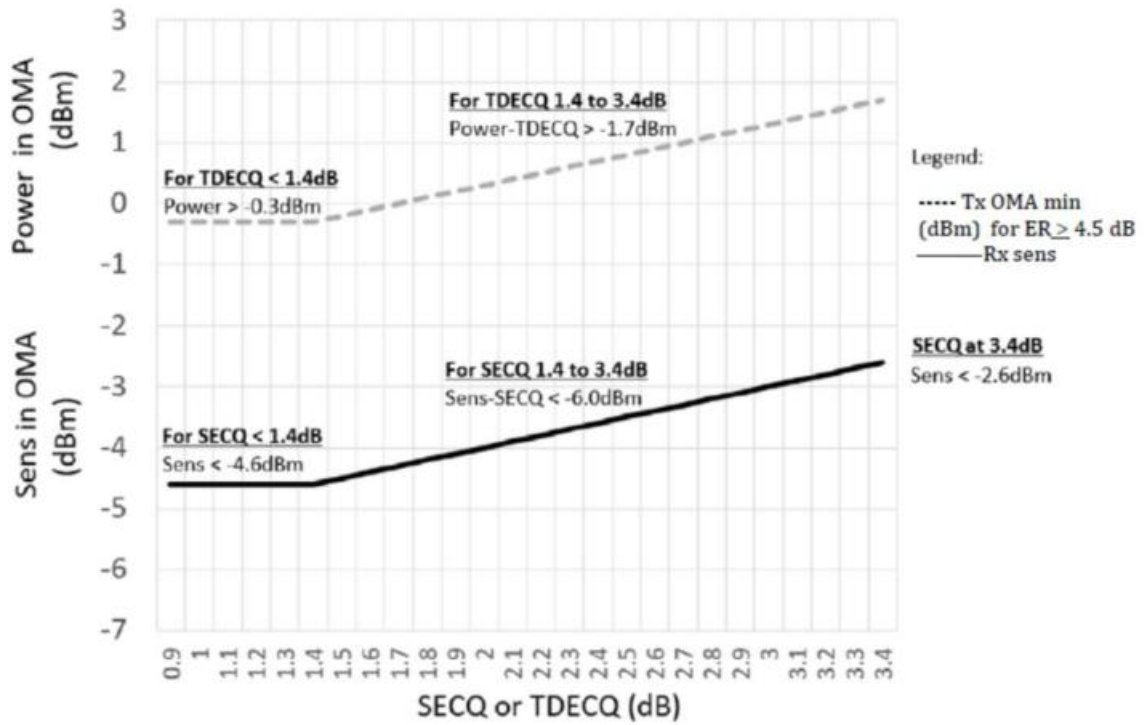
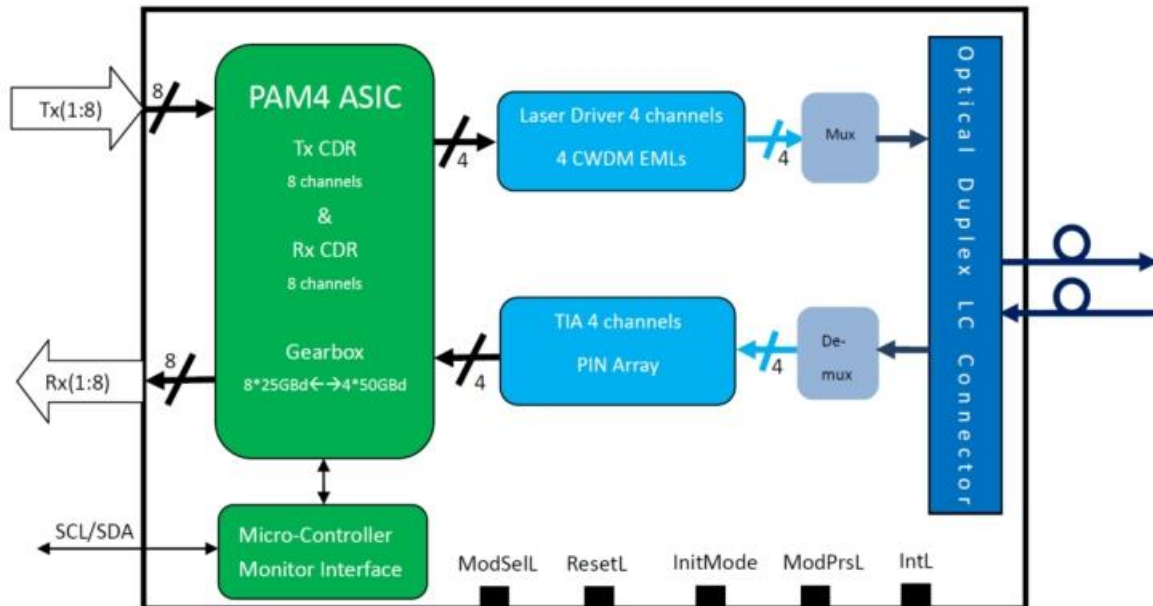


Illustration of Receiver Sensitivity Mask for 400G-FR4

## Block Diagram of Transceiver



This product is a 400Gb/s Quad Small Form Factor Pluggable-double density (QSFP-DD) optical module designed for 2km optical communication applications. The module converts 8 channels of 50Gb/s (PAM4) electrical input data to 4 channels of CWDM optical signals, and multiplexes them into a single channel for 400Gb/s optical transmission. Reversely, on the receiver side, the module optically de-multiplexes a 400Gb/s optical input into 4 channels of CWDM optical signals, and converts them to 8 channels of 50Gb/s (PAM4) electrical output data.

The central wavelengths of the 4 CWDM channels are 1271, 1291, 1311 and 1331 nm as members of the CWDM wavelength grid defined in ITU-T G.694.2. It contains a duplex LC connector for the optical interface and a 76-pin connector for the electrical interface. To minimize the optical dispersion in the long-haul system, single-mode fiber (SMF) has to be applied in this module. Host FEC is required to support up to 2km fiber transmission

The product is designed with form factor, optical/electrical connection and digital diagnostic interface according to the QSFP-DD Multi-Source Agreement (MSA) Type 2. It has been designed to meet the harshest external operating conditions including temperature, humidity and EMI interference.

The module incorporates 4 independent channels on CWDM4 1271/1291/1311/1331nm center wavelength, operating at 100G per channel. The transmitter path incorporates a quad channel EML driver and EML lasers together with an optical multiplexer. On the receiver path, an optical de-multiplexer is coupled to a 4 channel photodiode array. A DSP basis gearbox is used to convert 8 channels of 25GBaud PAM4 signals into 4 channels of 50GBaud PAM4 signals and also an 8-channel retimer and FEC block are integrated in this DSP. The electrical interface is compliant with IEEE 802.3bs and QSFP-DD MSA in the transmitting and receiving directions, and the optical interface is compliant to IEEE 802.3bs with duplex LC connector.



A single +3.3V power supply is required to power up this product. All the power supply pins are internally connected and should be applied concurrently. As per MSA specifications the module offers seven low speed hardware control pins (including the 2-wire serial interface): ModSelL, SCL, SDA, ResetL, InitMode, ModPrsL and IntL.

Module Select (ModSelL) is an input pin. When held low by the host, this product responds to 2-wire serial communication commands. The ModSelL allows the use of this product on a single 2-wire interface bus – individual ModSelL lines must be used.

Serial Clock (SCL) and Serial Data (SDA) are required for the 2-wire serial bus communication interface and enable the host to access the memory map.

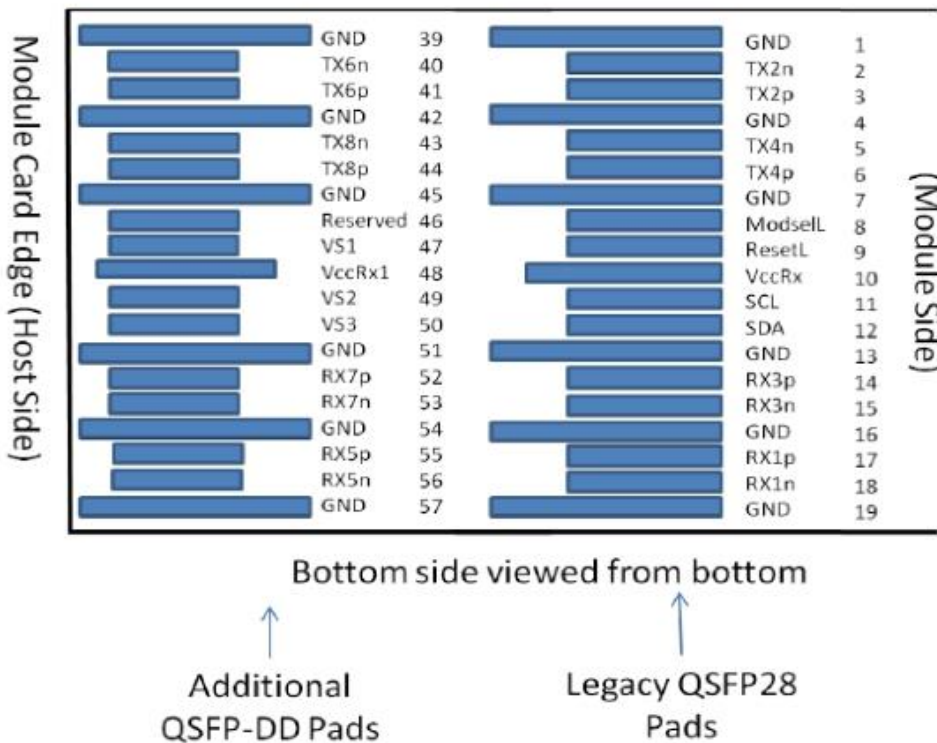
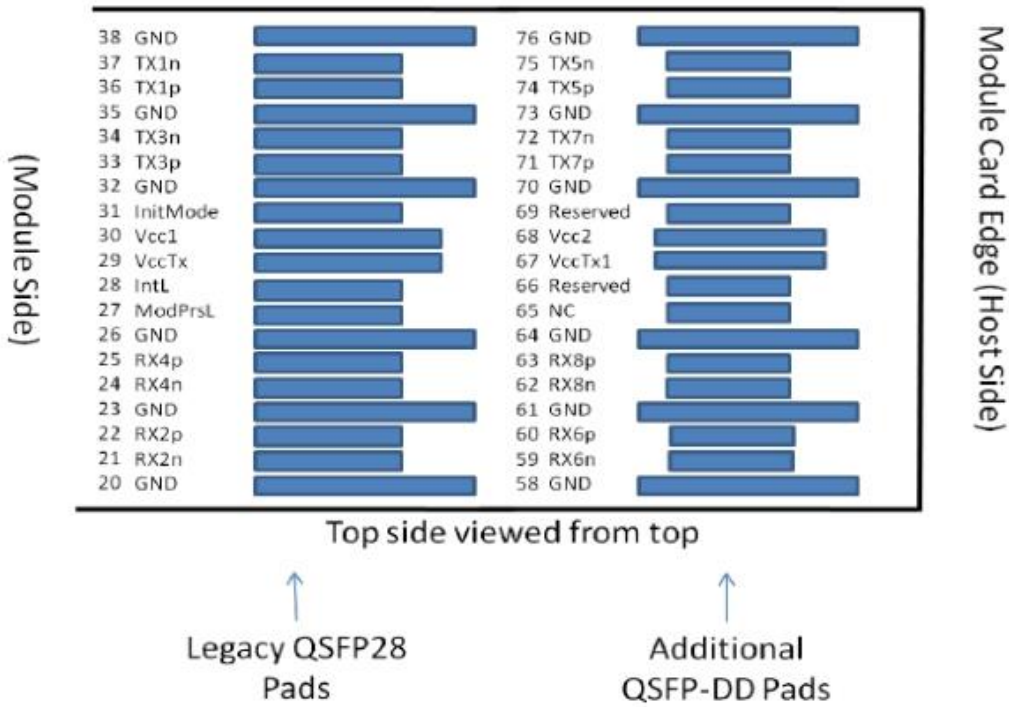
The ResetL pin enables a complete reset, returning the settings to their default state, when a low level on the ResetL pin is held for longer than the minimum pulse length. During the execution of a reset the host shall disregard all status bits until it indicates a completion of the reset interrupt. The product indicates this by posting an IntL (Interrupt) signal with the Data\_Not\_Ready bit negated in the memory map. Note that on power up (including hot insertion) the module should post this completion of reset interrupt without requiring a reset.

Initialize Mode (InitMode) is an input signal. It is pulled up to Vcc in the QSFP-DD module. The InitMode signal allows the host to define whether the QSFP-DD module will initialize under host software control (InitMode asserted High) or module hardware control (InitMode deasserted Low). Under host software control, the module shall remain in Low Power Mode until software enables the transition to High Power Mode, as defined in the QSFP-DD Management Interface Specification. Under hardware control (InitMode de-asserted Low), the module may immediately transition to High Power Mode after the management interface is initialized. The host shall not change the state of this signal while the module is present. In legacy QSFP applications, this signal is named LPMMode. See SFF-8679 for LPMMode signal description.

Module Present (ModPrsL) is a signal local to the host board which, in the absence of a product, is normally pulled up to the host Vcc. When the product is inserted into the connector, it completes the path to ground through a resistor on the host board and asserts the signal. ModPrsL then indicates its present by setting ModPrsL to a “Low” state.

Interrupt (IntL) is an output pin. “Low” indicates a possible operational fault or a status critical to the host system. The host identifies the source of the interrupt using the 2-wire serial interface. The IntL pin is an open collector output and must be pulled to the Host Vcc voltage on the Host board.

**Optical interface and Pin Assignment**

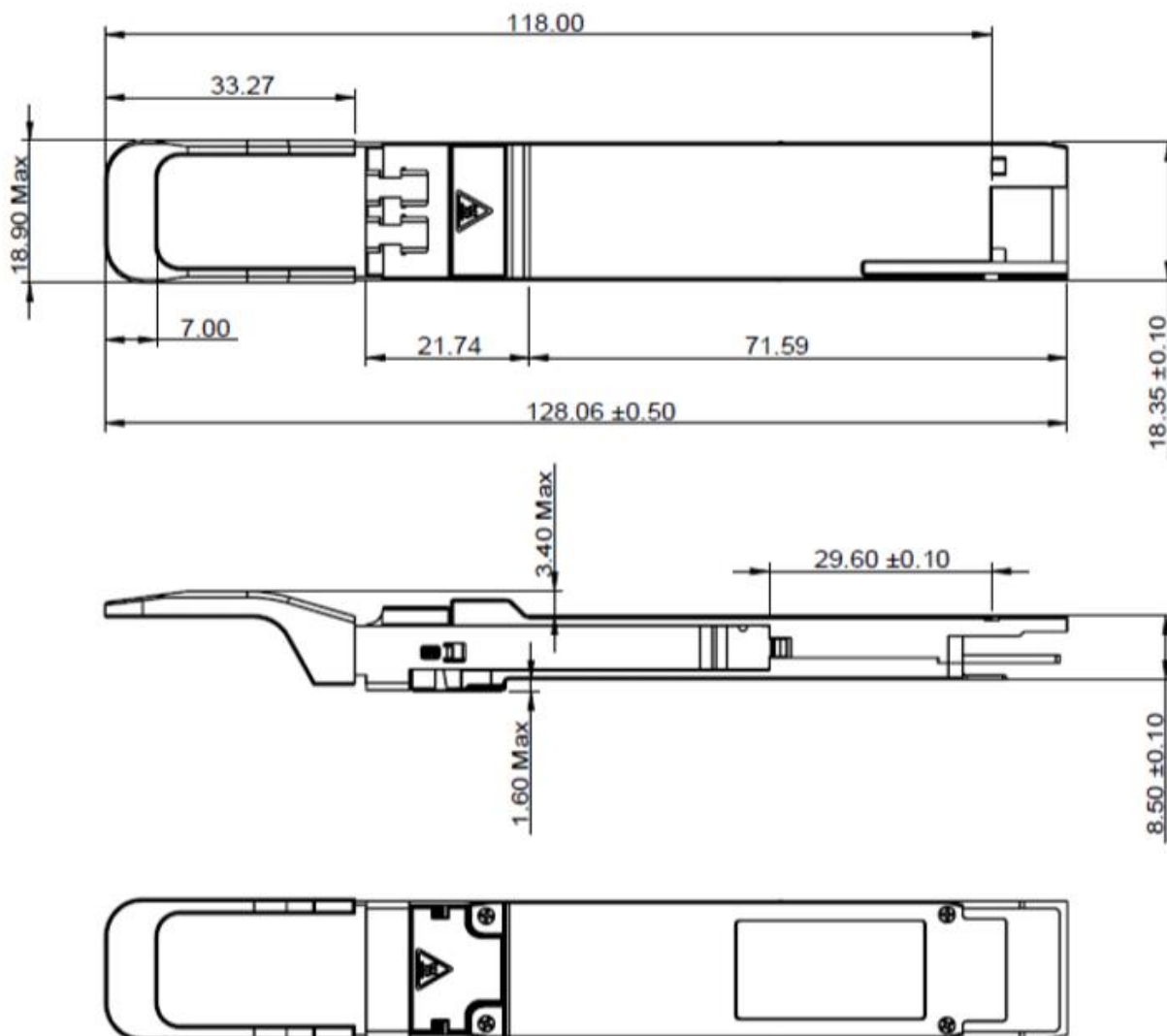


## Pin Description

Pin #	Logic	Symbol	Description	Plug Sequence
1		GND	Ground	1B
2	CML-I	Tx2n	Transmitter Inverted Data Input	3B
3	CML-I	Tx2p	Transmitter Non-Inverted Data Input	3B
4		GND	Ground	1B
5	CML-I	Tx4n	Transmitter Inverted Data Input	3B
6	CML-I	Tx4p	Transmitter Non-Inverted Data Input	3B
7		GND	Ground	1B
8	LVTTL-I	ModSelL	Module Select	3B
9	LVTTL-I	ResetL	Module Reset	3B
10		VccRx	+3.3V Power Supply Receiver	2B
11	LVC MOS-I/O	SCL	2-wire serial interface clock	3B
12	LVC MOS-I/O	SDA	2-wire serial interface data	3B
13		GND	Ground	1B
14	CML-O	Rx3p	Receiver Non-Inverted Data Output	3B
15	CML-O	Rx3n	Receiver Inverted Data Output	3B
16		GND	Ground	1B
17	CML-O	Rx1p	Receiver Non-Inverted Data Output	3B
18	CML-O	Rx1n	Receiver Inverted Data Output	3B
19		GND	Ground	1B
20		GND	Ground	1B
21	CML-O	Rx2n	Receiver Inverted Data Output	3B
22	CML-O	Rx2p	Receiver Non-Inverted Data Output	3B
23		GND	Ground	1B
24	CML-O	Rx4n	Receiver Inverted Data Output	3B
25	CML-O	Rx4p	Receiver Non-Inverted Data Output	3B
26		GND	Ground	1B
27	LVTTL-O	ModPrsL	Module Present	3B
28	LVTTL-O	IntL	Interrupt	3B
29		VccTx	+3.3V Power supply transmitter	2B
30		Vcc1	+3.3V Power supply	2B
31	LVTTL-I	InitMode	Initialization mode; In legacy QSFP applications, the InitMode pad is called LPMODE	3B
32		GND	Ground	1B
33	CML-I	Tx3p	Transmitter Non-Inverted Data Input	3B
34	CML-I	Tx3n	Transmitter Inverted Data Input	3B
35		GND	Ground	1B
36	CML-I	Tx1p	Transmitter Non-Inverted Data Input	3B
37	CML-I	Tx1n	Transmitter Inverted Data Input	3B

Pin #	Logic	Symbol	Description	Plug Sequence
38		GND	Ground	1B
39		GND	Ground	1A
40	CML-I	Tx6n	Transmitter Inverted Data Input	3A
41	CML-I	Tx6p	Transmitter Non-Inverted Data Input	3A
42		GND	Ground	1A
43	CML-I	Tx8n	Transmitter Inverted Data Input	3A
44	CML-I	Tx8p	Transmitter Non-Inverted Data Input	3A
45		GND	Ground	1A
46		Reserved	For future use	3A
47		VS1	Module Vendor Specific 1	3A
48		VccRx1	3.3V Power Supply	2A
49		VS2	Module Vendor Specific 2	3A
50		VS3	Module Vendor Specific 3	3A
51		GND	Ground	1A
52	CML-O	Rx7p	Receiver Non-Inverted Data Output	3A
53	CML-O	Rx7n	Receiver Inverted Data Output	3A
54		GND	Ground	1A
55	CML-O	Rx5p	Receiver Non-Inverted Data Output	3A
56	CML-O	Rx5n	Receiver Inverted Data Output	3A
57		GND	Ground	1A
58		GND	Ground	1A
59	CML-O	Rx6n	Receiver Inverted Data Output	3A
60	CML-O	Rx6p	Receiver Non-Inverted Data Output	3A
61		GND	Ground	1A
62	CML-O	Rx8n	Receiver Inverted Data Output	3A
63	CML-O	Rx8p	Receiver Non-Inverted Data Output	3A
64		GND	Ground	1A
65		NC	No Connect	3A
66		Reserved	For future use	3A
67		VccTx1	3.3V Power Supply	2A
68		Vcc2	3.3V Power Supply	2A
69		Reserved	For Future Use	3A
70		GND	Ground	1A
71	CML-I	Tx7p	Transmitter Non-Inverted Data Input	3A
72	CML-I	Tx7n	Transmitter Inverted Data Input	3A
73		GND	Ground	1A
74	CML-I	Tx5p	Transmitter Non-Inverted Data Input	3A
75	CML-I	Tx5n	Transmitter Inverted Data Input	3A
76		GND	Ground	1A

**Dimensions**



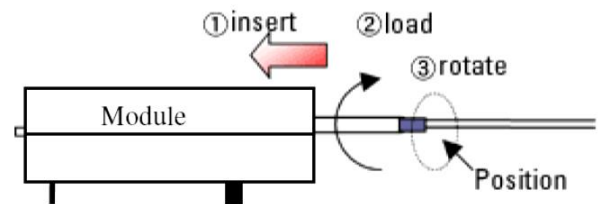
**Optical Receptacle Cleaning Recommendations:**

All fiber stubs inside the receptacle portions were cleaned before shipment. In the event of contamination of the optical ports, the recommended cleaning process is the use of forced nitrogen. If contamination is thought to have remained, the optical ports can be cleaned using a NTT international Cletop® stick type and HFE7100 cleaning fluid. Before the mating of patch-cord, the fiber end should be cleaned up by using Cletop® cleaning cassette.

**Cleaning of patch-cord**



**Cleaning of fiber stub**

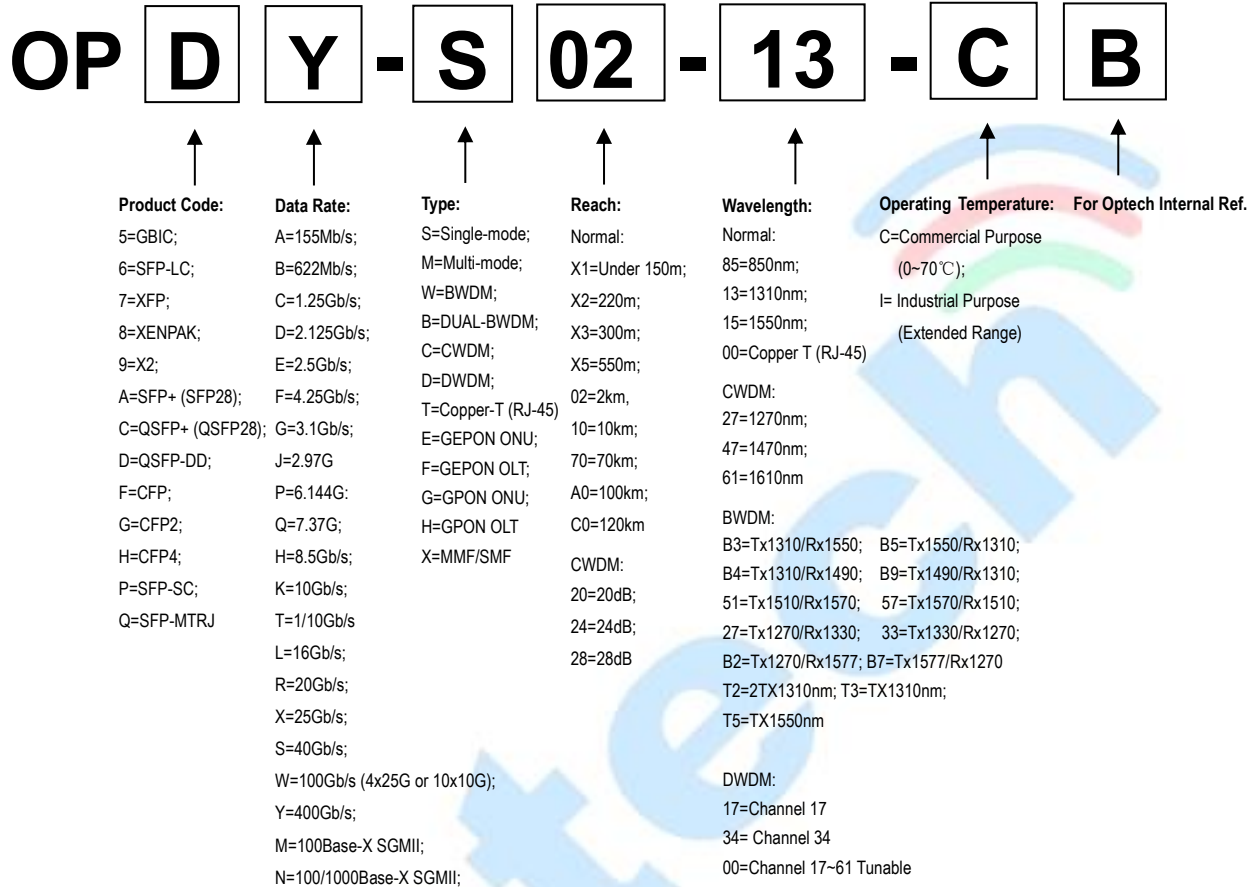


1. Insert  
Ensure that stick is held straight when inserting into sleeve.
2. Load  
Apply sufficient pressure (approx 600-700g) to ensure ferrule a little depressed in sleeve.
3. Rotate  
Rotate stick clockwise 4-5 times, while ensuring direct contact with ferrule end-face is maintained.

*Notice: Number of possible wipes:  
Maintenance (repair) ~1 use / piece  
Equipment construction: 4 uses / piece (max.)*

Note: The pictures were extracted from NTT-ME website. And the Cletop® is a trademark registered by NTT-ME

**Ordering Information**



Model Number	Part Number	Voltage	Temperature
QSFP-DD-400G-FR4	OPDY-S02-13-CB	3.3V	0°C to 70°C

**Note: All information contained in this document is subject to change without notice.**